



**TRANSMITTAL OF FORMAL DRAWINGS**

Docket No.  
**YOR920030336US1 (16898)**

In Re Application Of: **Timothy J. Dalton, et al.**

Application No.	Filing Date	Confirmation No.	Examiner	Customer No.	Group Art Unit
10/685,012	10/14/03	4288	Edgardo Ortiz	23389	2815

Invention: **PHOTORESIST ASH PROCESS WITH REDUCED INTER-LEVEL DIELECTRIC (ILD) DAMAGE**

Address to:  
**Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450**

Transmitted herewith are:

**2** sheets of formal drawing(s) for this application.

☒ Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c).

*Signature*

**Leslie S. Szivos, Ph.D.  
Registration No. 39,394**

Dated: **November 5, 2004**

I certify that this document and attached formal drawings are being deposited on **11/05/04** with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

*Signature of Person Mailing Correspondence*

**Leslie S. Szivos, Ph.D.**

*Typed or Printed Name of Person Mailing Correspondence*